INTER - UNIVERSITY ACCELERATOR CENTRE

(An Autonomous Centre of UGC)

Aruna Asaf Ali Marg, New Delhi - 110067

NOTICE INVITING E - TENDER

Tender Number : IUAC/NIT/ 29/KNS/2020-21

Dated : 04/03/2021

Inter - University Accelerator Centre (IUAC) invites online bids on behalf of the Director IUAC, New Delhi through e-procurement Portal under single bid system, viz., Financial bid, from OEM/distributor(s) for the work/supply of **"Discrete electronics components for indigenous VME modules development for control electronics of Pelletron accelerator"**.

Tender Documents may be downloaded from Central Public Procurement (CPP) Portal free of cost https://eprocure.gov.in/eprocure/app. Aspiring Bidders who have not enrolled / registered in eprocurement portal should enroll / register before participating through the website https://eprocure.gov.in/eprocure/app. Bids should be submitted online only at website: https://eprocure.gov.in/eprocure/app. Tenderers / Contractors / Bidders are advised to follow the instructions provided in the e-procurement portal. Bid documents may be scanned with 100 dpi with black and white option which helps in reducing size of the scanned documents.

Only bids received through e-procurement portal will be considered for opening. Bids not covering full scope of work/supply of the products/goods will be rejected and only complete bids will be considered. IUAC reserves the right to accept / reject any / all tenders in part / full without assigning any reasons whatsoever, and the decision of IUAC in this regard will be binding on all the bidders.

As per notification no. F/9/4/2020-PPD dated 12.11.2020 issued by Ministry of Finance, Department of Expenditure, Govt. of India, bidders have to submit "Bid Security Declaration" accepting that if withdraw or modify their bids during period of validity etc., they will be suspended for the time specified in the tender documents". Tenderers registered with MSME/NSIC (the unit being registered for the item/work tendered)are required to upload copy of valid registration certificate in the website https://eprocure.gov.in/eprocure/app along with technical bid.

Bidders are advised to note that they should necessarily submit their financial bids in the format provided and no other format is acceptable. If the price bid has been given as a standard .XLS BOQ Format with the tender document, then the same is to be downloaded and to be filled and submitted online without modifying the format. **If the BOQ file is found to be modified by the bidder, the bid will be rejected**.

Any Corrigendum / Amendments in respect of above tender shall be issued on website **https://eprocure.gov.in** and <u>www.iuac.res.in</u> only. Bidders should take into account any corrigendum published on the tender document before submitting their bids. The Director, IUAC reserves the right to accept/reject any/all tenders in part/full without assigning any reasons thereof.

<u>E - TENDER DOCUMENT</u>

Name of Work / Supply	Discrete electronics components for indigenous VME modules development for control electronics of Pelletron accelerator
Tender Number	IUAC/NIT/29 /KNS/2020-21
Tender Value / Estimate only	Rs. 9,81,738/- (Nine lakh eighty one thousand seven hundred thirty eight only)
Earnest Money Deposit	NIL
Tender Document Fee	NIL
Bid Submission End Date and Time	23/03/2021 at 03:00 P.M.
Techno Commercial Bid Opening Date	24/03/2021 at 03:00 P.M.
Contact Person	Administrative Officer (S&P)
	E-mail: <u>iuacstores@gmail.com</u>
	Phone: 011-24126018, 24126022.

General Terms and Conditions of the Tender :

1. Submission of Tender :

Tenders should be uploaded on CPP Portal in a single bid, i.e. Techno Commercial Bid / BOQ

2. Techno Commercial Bid :

I. <u>Prequalification of the bidder</u>

Only Original component Manufacturer (OEM) or their distributors (sales and service) representatives are eligible to quote.

The bidder must be an internationally reputed firm/company/manufacturer or their representative of supplying components to internationally reputed laboratories worldwide and within India. Only Original Equipment Manufacturer (OEM) or their distributors (sales and service) representatives/dealers are eligible to quote. No deviations in respect of NIT conditions are acceptable. In this bid, the bidder should upload the following documents :

- 1. Tender Acceptance Letter (written on company letter head, duly signed and stamped.) as per format provide in **Annexure A**, as a token of acceptance of the NIT conditions, with this bid.
- 2. Profile of the Tenderer as per Annexure B
- 3. Bid Security Declaration as **per Annexure C**

- 4. The quoted item should be a standard catalogue product, displayed prominently in product catalogue / OEM website.
- 5. The bidder should not be blacklisted by any Government, or Government Department, whether in the Central/State/District levels across India. An undertaking in this regard as per Annexure-B is enclosed with the Technical Bid.

Scope of work : As per the technical specifications and other details given in Annexure A.

II. <u>Price Bid Part</u> :

In the commercial part of the bid, the bidder is required to quote unconditional rates in the .XLS BOQ format provided with this tender. Quotes in INR will only be accepted.

The Indigenous suppliers quoting in INR should quote the rates all inclusive up to IUAC and excluding GST. IUAC is exempted from Customs Duty and GST and necessarily certificates shall be issued by IUAC along with the PO. The BOQ file must not be modified.

3. Earnest Money Deposit:

As per notification no.F/9/4/2020-PPD dated 12.11.2020 issued by Ministry of Finance, Department of Expenditure, Govt. of India, bidders have to submit "Bid Security Declaration" accepting that if withdraw or modify their bids during period of validity etc., they will be suspended for the time specified in the tender documents.

4. Validity of Tender:

Tender shall be valid for our acceptance without any change in the rates and NIT conditions for a period of 120 days from the date of opening the price bid. No escalation of cost will be acceptable in any condition after opening of tender.

5. <u>Escalation / Deviation</u> : No escalation or deviation shall be allowed till execution of order / contract.

6. <u>Terms of Payment</u> :

90% of the payment shall be made after the delivery of all the goods at IUAC. Balance 10% of the total payment will be retained as Security Deposit and shall be paid on completion of one year of warranty period.

7. Guarantee/Defect liability period:

The supplied material should guarantee for the manufacturing / engineering defect and bad material/workmanship for a minimum period of one year from the date of acceptance of the goods by IUAC. During this period if any replacement, repairs/rectification of any of the supplied item etc. is needed, the supplier shall do the same free of cost to IUAC.

8. <u>Timeline for supply:</u>

The material should be supplied within 90 days from the date of issue of Purchase order. Any delay in completion of the work/supply due to reasons attributable to the vendor / manufacturer is liable to liquidated damages as per clause 11 of this NIT. However, under the force-majeure conditions as per clause 12 of NIT, IUAC may grant suitable time extension for which vendor has to request along with the justification / reasons well in advance to the Director, IUAC for approval without any prejudice or price escalation.

9. Liquidated damages:

In case the delivery of the listed items is delayed beyond the specified delivery period for reasons attributable to the supplier, deductions on account of liquidated damages @ 1% per week subject to maximum of 10 % of the total order value will be deducted.

10. Force Majeure:

IUAC may grant an extension of time limit set for the supply items in case it is delayed by force majeure beyond the supplier's control. Force majeure is defined an event of effect that cannot reasonably be anticipated such as acts of God (like earthquakes, floods, tsunami etc.), the direct and indirect consequences of wars (declared or undeclared), national emergencies, civil commotions and strikes (only those which exceeds a duration of ten continuous days) at successful Tenderer's factory. Apart from the extension of the time limit, force majeure does not entitle the successful tenderer to any relaxation or to any compensation of damage or loss suffered. The decision of the Director, IUAC will be final and binding for the bidder.

11. Post Warranty Period:

In case of wrong/under rated component(s) supply, the buyer keeps rights reserved for choosing or not choosing the option. The response time for attending a fault should be maximum two weeks in case of Indian agent. In such cases the supplier will pay the travel, lodging, etc. charges.

12. Final Acceptance:

The final acceptance of the system is defined as successful completion of shipment, installation and acceptance tests at IUAC to substantiate compliance with the specification mentioned in annexure A.

13. Correspondence :

All the correspondence in respect of tender / contractual obligation shall be made to The Administrative Officer (S&P), Inter University Accelerator Centre, Aruna Asaf Ali Marg, New Delhi - 110067. E-mail : <u>iuacstores@gmail.com</u>, Phone : +91-11-24126018, 24126022.

14. Tender Rejection :

(a) Director, IUAC reserves the right to accept/reject any/all tenders in part/full without assigning any reason whatsoever and the decision of the IUAC in this regard will be binding on all the bidders.

(b) Bids received by means other than e - procurement portal will be rejected.

(c) If BOQ file is found to be modified by the bidder, the bid will be rejected. Only INR quote will be acceptable.

(e) Tenders not complying with any of the provisions stated in this tender document are liable to be rejected.

(f) If the General Terms and conditions are not accepted and not signed by the bidders, then the tender will be rejected.

(g) Tender will be rejected on non submission of 'Bid Security Declaration'.

15. The contract shall be governed by the Indian Laws. Any dispute arising out of this contract will be subjected to jurisdiction of New Delhi / Delhi only.

Accepted

(Signature of Bidder)

BOQ/PRICE BID

(Price should be quoted in the standard BOQ format of this tender, Incomplete price bid will be rejected)

Tender Inviting Authority: INTER UNIVERSITY ACCELERATOR CENTRE

Name of Work/Supply: <u>Discrete Electronics components</u>

1. **Description of the items**

	Annexure -1				
S.No.	Component Description	Part Number	Manufacturer	Qty	
1	PLUG-IN UNIT, 19", 6U, 4HP	20848-592	SCHROFF	50	
2	Analogue Switch, CMOS Quad, 4 Channels, SPST, 35 ohm, 5V to 34V, SOIC, 16 Pins	DG412DYZ	DG412DYZ RENESAS		
3	Potentiometers, 100E POT Trimmer 1000hm 0.25W GW TOP ADJ	TS63Y101KR10	VISHAY	50	
4	Potentiometers, 100kΩ POT Trimmer 100 Kilo Ohm 0.25W GW TOP ADJ	TS63Y104KR10 VISHAY		50	
5	Instrumentation Amplifiers Fast-Settling FET-In Very High Accuracy	INA110KU	INA110KU Texas		
6	Multiplexer Switch ICs SINGLE 16:1 DUAL 8:1 MUX	DG507BEW-T1-GE3 Silliconix		100	
7	Analog to Digital Converters - ADC IC, MONO 12-BIT ADC IC	AD1674BRZ Analog Devices		10	
8	Bus Transceivers 16-Bit Reg Trans	74LCX16543MTDX ON Semiconductor		150	
9	Linear Voltage Regulators 3P 1.5A Fixed 10V Pos Vltg Reg	UA7810CKTTR	R Texas Inst.		
10	Flip-Flops Dual Pos Edge Trig	SN74LS74AD	Texas Inst.	100	
11	Inverters Hex Schmitt-Trigger	SN74LS14D	Texas Inst.	100	
12	Buffers & Line Drivers Hex inverter Buffer/ Driver	SN74LS06D Texas Inst.		100	
13	Monostable Multi-vibrator Dual Mono	SN74LS123D Texas Inst.		100	
14	Bus Transceivers Octal Bus	SN74LS245DW	Texas Inst.	100	
15	Flip-Flops Tri-State Octal	SN74ALS574BDW	Texas Inst.	100	
16	Bus Transceivers Bidirectional Trans	74LCX245WMX	Texas Inst.	500	

17	Transistor Output Optocouplers Phototransistor Out Quad CTR >100%	ILQ2 Vishay		200
18	FPGA - Configuration Memory Flash 4Mb PROM	XCF04SVOG20C ST micro		50
19	Precision Amplifiers High Precision Oper Amplifier	OPA4277UA/2K5	RENESAS	160
20	Multiplexer Switch ICs MUX 8:1 16NSOIC IND	DG408DYZ	RENESAS	100
21	FPGA - Field Programmable Gate Array 400000 SYSTEM GATE 1.2 VOLT FPGA	XC3S400-4PQ208C	Xilinx	50
22	Digital to Analog Converters - DAC CMOS 12-BIT D/A CONVERTER	AD7545AKRZ	Analog Devices	15
23	Multiplexer Switch ICs +/-15V 8:1 Mux with Ron max = 5 Ohm	ADG1408YRUZ	Analog Devices	15
24	High Speed Operational Amplifiers Prec High-Speed Difet Oper Amp	OPA627AU/2K5	Analog Devices	25
25	Standard Clock Oscillators 9 40.000MHz 3.3V25ppm(- 10 +70C)	7C-40.000MBA-T	TXC corporation	75
26	LDO Voltage Regulators POWER MANAGEMENT	LD1086V33-DG	1086V33-DG ST micro	
27	LDO Voltage Regulators 1.8V 0.8A Positive	LD1117V18	ST micro	15
28	Linear Voltage Regulator IC Output	FAN1589T Fairchild Semi		100
29	Isolated DC/DC Converters DC-DC CONVERTER, 5W, 2:1, DIP24	JCD0505S15	XP Power	25
30	Isolated DC/DC Converters DC-DC CONVERTER, 5W, 2:1, DIP24	JCD0605D15 XP Power		10
31	DC-DC Converter	WRA0515D-10W	MORNSUN	25
32	Linear Voltage Regulators 3P 1.5A Fixed 10V Pos Vltg Reg	UA7810CKTTR	Texas Inst.	25
33	Linear Voltage Regulators 3-Term Adj Reg	LM337LZ/NOPB	Texas Inst.	25
34	FPGA, Spartan-6, DCM, PLL, 102 I/O's, 375 MHz, 9152 Cells, 1.14 V to 1.26 V, TQFP-144	XC6SLX9-2TQG144I Xilinx		10
35	FPGA - Field Programmable Gate Array FPGA - Cyclone IV GX 1840 LABs 290 IOs	EP4CGX30CF23C7N Intel/Altera		1
36	SRAM 9Mb 133Mhz 512K x 18 Flow-Thru SRAM	CY7C1363C-133AXC	Cypress Semiconductor	1
37	NOR Flash	N25Q032A13ESC40G	Alliance Memory	2

38	FFC & FPC Connectors 24P R/A SMT FFC/FPC 0.5mm CONT SPACING	SFV24R-4STE1HLF	Amphenol FCI	10
39	FFC / FPC Jumper Cables WR-FFC 0.5mm Type 2 24P 100mm length	710-687724100002	Wurtz Electronik	1
40	FFC / FPC Jumper Cables FFC 0.50 Type A 2 4 ckts Igt 76	538-15166-0253	Molex	1

	Annexure -2				
1	Bipolar Transistors - BJT 500mA 60V NPN	MMBTA05LT1G	ON Semiconductor	1000	
2	Bipolar Transistors - BJT 500mA 60V PNP	MMBTA55LT1G	ON Semiconductor	1000	
3	Diodes - General Purpose, Power, Switching 85V 250mW	BAS116-7-F	Diodes Incorporated	3000	
4	Schottky Diodes & Rectifiers 30V 225mW Dual	BAT54SLT1G	ON Semiconductor	3000	
5	SMD Chip Resistor, 1 kohm, ± 1%, 500 mW, 1210 [3225 Metric], Thick Film, General Purpose	CRCW12101K00FKEA	Vishay	3000	
6	SMD Chip Resistor, 1.62 kohm, ± 1%, 500 mW, 1210 [3225 Metric], Thick Film, High Power, Anti-Surge	ERJP14F1621U	Panasonic	3000	
7	SMD Chip Resistor, 3.32 kohm, ± 1%, 500 mW, 1210 [3225 Metric], Thick Film, High Power, Anti-Surge	ERJP14F3321U	Panasonic	3000	
8	SMD Chip Resistor, 10 kohm, ± 1%, 500 mW, 1210 [3225 Metric], Thick Film, General Purpose	CRCW121010K0FKEA	Vishay	3000	
9	RES, THICK FILM, 220R, 1%, 0.5W, 1210	CRCW1210220RFKEA	Vishay	3000	
10	SMD Chip Resistor, 330 ohm, ± 1%, 500 mW, 1210 [3225 Metric], Thick Film, General Purpose	CRCW1210330RFKEA	Vishay	3000	
11	RES, THICK FILM, 680R, 1%, 0.5W, 1210	CRCW1210680RFKEA	Vishay	3000	
12	SMD Chip Resistor, 1.5 kohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, High Power	MCWF08P1501FTL	MULTICOMP	3000	

13	SMD Chip Resistor, 1.8 kohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, High Power	WF08P1801FTL	WALSIL	3000
14	SMD Chip Resistor, 200 ohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, Precision	RK73H2ATTD2000F	КОА	2500
15	SMD Chip Resistor, 10 kohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, High Power	MCWF08P1002FTL	MULTICOMP	3000
16	SMD Chip Resistor, 100 ohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, High Power	MCWF08P1000FTL	MULTICOMP	2500
17	Fixed Network Resistor, 10 kohm, 4600M Series, 8 Elements, Bussed, SIP, 9 Pins	4609M-101-103LF	BOURNS	500
18	SMD Chip Resistor, 4.7 kohm, ± 1%, 250 mW, 0805 [2012 Metric], Thick Film, High Power	MCWF08P4701FTL	MULTICOMP	2500
19	SMD Multilayer Ceramic Capacitor, 0.1 µF, 50 V, 0805 [2012 Metric], ± 5%, X7R, VJ Series	VJ0805Y104JXATW1BC	Vishay	5000
20	SMD Multilayer Ceramic Capacitor, 0.1 μ F, 50 V, 1206 [3216 Metric], ± 5%, X7R, MC Series	MC1206B104J500CT	Vishay	1000
21	SMD Multilayer Ceramic Capacitor, 270 pF, 50 V, 0805 [2012 Metric], ± 5%, C0G / NP0, MC Series	MC0805N271J500CT	MULTICOMP	4000
22	CAPACITOR, MLCC, X7R, 2.2UF, 50V, 0805	UMK212BB7225KG-T	TAIYO YUDEN	1000
23	SMD Multilayer Ceramic Capacitor, 1000 pF, 50 V, 0805 [2012 Metric], ± 10%, X7R, MC Series	MC0805B102K500CT	MULTICOMP	2000
24	SMD Multilayer Ceramic Capacitor, 22000 pF, 50 V, 1206 [3216 Metric], ± 10%, X7R, MC Series	MC1206B223K500CT	MULTICOMP	2000
25	SMD Multilayer Ceramic Capacitor, 10000 pF, 50 V, 0805 [2012 Metric], ± 10%, X7R, MC Series	MC0805B103K500CT	MULTICOMP	1000

26	Tantalum Capacitors - Solid SMD 20V 47uF 2917	T491D476K020AT	KEMET	500	
	10% ESR=700mOhms				

ANNEXURE-A

TENDER ACCEPTANCE LETTER Page 9 of 15

Date:

To, The Director IUAC, New Delhi-67

Sub: Acceptance of Terms & Conditions of Tender.

Tender Reference No: IUAC/NIT/29 /KNS/2020-2021 Name of Tender / Work: - Supply of Discrete Electronics components per Annexure-1&2

Dear Sir,

I/ We have downloaded / read and examined the tender document(s) for the above mentioned Tender /Work from the web site(s) namely:

as per your advertisement, given in the above mentioned website(s).

- 1. I/We hereby certify that I/we have read the entire terms and conditions of the tender documents (including all documents like annexure(s), schedule(s), etc.), which form part of the contract agreement and I / we shall abide hereby by the terms / conditions / clauses contained therein.
- 2. The corrigendum(s) issued from time to time by your department/ organization too have also been taken into consideration, while submitting this acceptance letter.
- 3. I / We hereby unconditionally accept the tender conditions of above mentioned tender document(s) / corrigendum(s) in its totality / entirety.
- 4. I/We do hereby declare that our Firm has not been blacklisted/ debarred by any Govt. Department/Public sector undertaking.
- 5. I/We certify that all information furnished by the our Firm is true & correct and in the event that the information is found to be incorrect/untrue or found violated, then your department/ organization shall without giving any notice or reason therefore or summarily reject the bid or terminate the contract, without prejudice to any other rights or remedy.

Yours Faithfully,

(Signature of the Bidder, with Official Seal)

INSTRUCTION TO BIDDERS FOR ONLINE BID SUBMISSION

The bidders are required to submit soft copies of their bids electronically on the CPP Portal. The instructions given below are meant to assist the bidders in registering on the CPP Portal, prepare their bids in accordance with the requirements and submitting their bids online on the CPP Portal.

More information useful for submitting online bids on the CPP Portal may be obtained at: https://eprocure.gov.in/eprocure/app .

REGISTRATION

- 1) Bidders are required to enroll on the e-Procurement module of the Central Public Procurement Portal (URL: https://eprocure.gov.in/eprocure/app) by clicking on the link "Online bidder Enrollment" on the CPP Portal which is free of charge.
- 2) As part of the enrollment process, the bidders will be required to choose a unique user name and assign a password for their accounts.
- 3) Bidders are advised to register their valid email address and mobile numbers as part of the registration process. These would be used for any communication from the CPP Portal.
- 4) Bidder then logs in to the site through the secured log-in by entering their user ID / password

SEARCHING FOR TENDER DOCUMENTS

- 1. There are various search options built in the CPP Portal, to facilitate bidders to search active tenders by several parameters. These parameters could include Tender ID, Organization Name, Location, Date, Value, etc. There is also an option of advanced search for tenders, wherein the bidders may combine a number of search parameters such as Organization Name, Form of Contract, Location, Date, Other keywords etc. to search for a tender published on the CPP Portal.
- 2. Once the bidders have selected the tenders they are interested in, they may download the required documents / tender schedules. These tenders can be moved to the respective "My Tenders" folder. This would enable the CPP Portal to intimate the bidders through SMS / e-mail in case there is any corrigendum issued to the tender document.
- 3. The bidder should make a note of the unique Tender ID assigned to each tender, in case they want to obtain any clarification / help from the Help desk.

PREPARATION OF BIDS

- 1) Bidder should take into account any corrigendum published on the tender document before submitting their bids.
- 2) Please go through the tender advertisement and the tender document carefully to understand the documents required to be submitted as part of the bid. Please note the

number of covers in which the bid documents have to be submitted, the number of documents - including the names and content of each of the document that need to be submitted. Any deviations from these may lead to rejection of the bid.

- 3) Bidder, in advance, should get ready the bid documents to be submitted as indicated in the tender document / schedule and generally, they can be in PDF / XLS /JPG formats. Bid documents may be scanned with 100 dpi with black and white option which helps in reducing size of the scanned document.
- 4) To avoid the time and effort required in uploading the same set of standard documents which are required to be submitted as a part of every bid, a provision of uploading such standard documents (e.g. PAN card copy, annual reports, auditor certificates etc.) has been provided to the bidders. Bidders can use "My Space" or ""Other Important Documents" area available to them to upload such documents. These documents may be directly submitted from the "My Space" area while submitting a bid, and need not be uploaded again and again. This will lead to a reduction in the time required for bid submission process.

SUBMISSION OF BIDS

- 1. Bidder should log into the site well in advance for bid submission so that they can upload the bid in time i.e. on or before the bid submission time. Bidder will be responsible for any delay due to other issues.
- 2. The bidder has to digitally sign and upload the required bid documents one by one as indicated in the tender document.
- 3. Bidders are requested to note that they should necessarily submit their bids in the format provided and no other format is acceptable. If the price bid has been given as a standard BOQ format with the tender document, then the same is to be downloaded and to be filled by all the bidders. Bidders are required to download the BOQ file, open it and complete the white coloured (unprotected) cells with their respective financial quotes and other details (such as name of the bidder). No other cells should be changed. Once the details have been completed, the bidder should save it and submit it online, without changing the file name. If the BOQ file is found to be modified by the bidder, the bid will be rejected.
- 4. The server time (which is displayed on the bidders" dashboard) will be considered as the standard time for referencing the deadlines for submission of the bids by the bidders, opening of bids etc. The bidders should follow this time during bid submission.
- 5. All the documents being submitted by the bidders would be encrypted using PKI encryption techniques to ensure the secrecy of the data. The data entered cannot be viewed by unauthorized persons until the time of bid opening. The confidentiality of the bids is maintained using the secured Socket Layer 128 bit encryption technology. Data storage encryption of sensitive fields is done. Any bid document that is uploaded to the

server is subjected to symmetric encryption using a system generated symmetric key. Further this key is subjected to asymmetric encryption using buyers/bid opener's public keys. Overall, the uploaded tender documents become readable only after the tender opening by the authorized bid openers.

- 6. The uploaded tender documents become readable only after the tender opening by the authorized bid openers.
- 7. Upon the successful and timely submission of bids (i.e. after Clicking "Freeze Bid Submission" in the portal), the portal will give a successful bid submission message & a bid summary will be displayed with the bid no. and the date & time of submission of the bid with all other relevant details.
- 8. The bid summary has to be printed and kept as an acknowledgment of the submission of the bid. This acknowledgment may be used as an entry pass for any bid opening meetings.

ASSISTANCE TO BIDDERS

- 1) Any queries relating to the tender document and the terms and conditions contained therein should be addressed to the Tender Inviting Authority for a tender or the relevant contact person indicated in the tender.
- Any queries relating to the process of online bid submission or queries relating to CPP Portal in general may be directed to the 24x7 CPP Portal Help desk. The contact number for the help desk is 1800 3070 2232.

Annexure-B

PROFILE OF THE TENDERER

(To be given on Company Letter Head)

TENDER FOR SUPPLY OF Discrete Electronics components

- 1. Name of the Firm/Organization :
- 2. Address
- 3. Telephone No. / Mobile No. & Name of The Contact Person:

:

:

- 4. FaxNo.
- 5. E-mail ID :
- 6. Month and Year of establishment :
- 7. Name of proprietor/partners/director :
- No. of years of experience in this field,
 With Reference, Certificates :
- 9. Annual Turnover during the last three years (Enclose copies of Audited Financial Statement)

<u>2017-18:</u>

<u>2018-19:</u>

2019-20:

- 10. Whether the firm is an Income Tax Assessee? If so please give the details of PAN No. :
- 11. GST Registration No.:

Annexure -C

BID SECURITY DECLARATION

(To be given on Company Letter Head)

As per notification no.F/9/4/2020-PPD dated 12.11.2020 issued by Ministry of Finance, Department of Expenditure, Govt. of India, I/We hereby accepting that if the bids related to "**Supply of discrete electronics components**" are withdrawn or modified during the period of validity etc., IUAC has right to suspend the bid for the time specified in the tender documents.

Signature of the Tenderer & Seal